LM79L05,LM79L05AC,LM79L12,LM79L12AC, LM79L15,LM79L15AC

LM79LXXAC Series 3-Terminal Negative Regulators



Literature Number: SNOSBR8J



LM79LXXAC Series

3-Terminal Negative Regulators

General Description

The LM79LXXAC series of 3-terminal negative voltage regulators features fixed output voltages of –5V, –12V, and –15V with output current capabilities in excess of 100mA. These devices were designed using the latest computer techniques for optimizing the packaged IC thermal/electrical performance. The LM79LXXAC series, when combined with a minimum output capacitor of 0.1 μ F, exhibits an excellent transient response, a maximum line regulation of 0.07% V_O/WA.

The LM79LXXAC series also includes, as self-protection circuitry: safe operating area circuitry for output transistor power dissipation limiting, a temperature independent short circuit current limit for peak output current limiting, and a thermal shutdown circuit to prevent excessive junction temperature. Although designed primarily as fixed voltage regulators, these devices may be combined with simple external circuitry for boosted and/or adjustable voltages and currents. The LM79LXXAC series is available in the 3-lead TO-92 package.

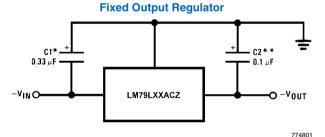
the 8-lead SOIC package, and the 6-Bump micro-SMD package.

For output voltages other than the pre-set -5V, -12V and -15V, the LM137L series provides an adjustable output voltage range from -1.2V to -47V.

Features

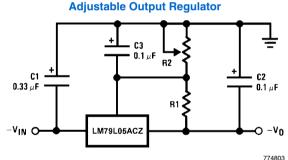
- Preset output voltage error is less than ±5% overload, line and temperature
- Specified at an output current of 100mA
- Easily compensated with a small 0.1µF output capacitor
- Internal short-circuit, thermal and safe operating area protection
- Easily adjustable to higher output voltages
- Maximum line regulation less than 0.07% V_{OUT}/V
- Maximum load regulation less than 0.01% V_{OUT}/mA
- See AN-1112 for micro-SMD considerations

Typical Applications



*Required if the regulator is located far from the power supply filter. A $1\mu F$ aluminum electrolytic may be substituted.

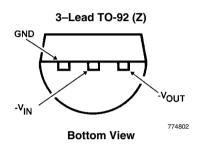
^{**}Required for stability. A 1μF aluminum electrolytic may be substituted.



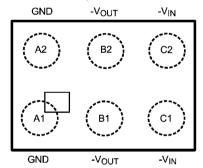
 $-V_0 = -5V - (5V/R1 + I_Q) \bullet R2,$ 5V/R1 > 3 I_O

Connection Diagrams

Pins labeled 'NC' on LM79LXXACM 8-Lead SOIC (pin 4 and pin 8) are Open, no internal connection. **Top View**



6-Bump micro-SMD



Top View (Bump Side Down) 774820

Ordering Information

Package	Part Number	Package Marking	Transport Media	NSC Drawing	
8-Lead SOIC	LM79L05ACM	LM79L	Rail of 95		
	LM79L05ACMX	05ACM	Reel of 2500		
	LM79L12ACM	LM79L	Rail of 95	M00 A	
	LM79L12ACMX	12ACM	Reel of 2500	M08A	
	LM79L15ACM	LM79L	Rail of 95		
	LM79L15ACMX	15ACM	Reel of 2500		
3-Pin TO-92	LM79L05ACZ	320L 79L05	Box of 1800		
	LM79L12ACZ	320L 79L12	Box of 1800	Z03A	
	LM79L15ACZ	320L 79L15	Obsolete		
6-Bump	LM79L05ACTL	XVP	Reel of 250	TLA06AMA	
micro-SMD	LM79L05ACTLX	IB	Reel of 3000	T LAUGAIVIA	

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Input Voltage

 $V_{O} = -5V, -12V, -15V$

-35V

Internal Power Dissipation (*Note 2*)
Operating Temperature Range
Maximum Junction Temperature
Storage Temperature Range
Lead Temperature
(Soldering, 10 sec.)

Internally Limited 0°C to +70°C +125°C -55°C to +150°C

260°C

Electrical Characteristics (Note 3)

 $T_{\Delta} = 0^{\circ}C$ to $+70^{\circ}C$ unless otherwise noted.

Output Voltage			-5V		-12V			-15V				
Input Voltage (unless otherwise noted)			-10V		-17V		-20V		Units			
Symbol	Parameter	Conditions	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
V _o	Output Voltage	$T_J = 25^{\circ}C, I_O = 100mA$	-5.2	-5	-4.8	-12.5	-12	-11.5	-15.6	-15	-14.4	
		1mA ≤ I _O ≤ 100mA	-5.25		-4.75	-12.6		-11.4	-15.75		-14.25	
		$V_{MIN} \le V_{IN} \le V_{MAX}$	(–20 ≤	V _{IN} ≤ -	7.5)	(–27 ≤	V _{IN} ≤ -	14.8)	(-30 ≤	V _{IN} ≤ -	-18)	V
		1mA ≤ I _O ≤ 40mA	-5.25		-4.75	-12.6		-11.4	-15.75		-14.25	
		$V_{MIN} \le V_{IN} \le V_{MAX}$	(–20 ≤	V _{IN} ≤ -	-7)	(–27 ≤	V _{IN} ≤ -	14.5)	(-30 ≤	V _{IN} ≤ -	-17.5)	
		$T_J = 25^{\circ}C, I_O = 100mA$			60			45			45	mV
۸۱/	Line	$V_{MIN} \le V_{IN} \le V_{MAX}$	(–20 ≤	V _{IN} ≤ -	-7.3)	(–27 ≤	V _{IN} ≤ -	14.6)	(-30 ≤	V _{IN} ≤ -	-17.7)	V
ΔV _O	Regulation	$T_J = 25^{\circ}C, I_O = 40mA$			60			45			45	mV
		$V_{MIN} \le V_{IN} \le V_{MAX}$	(–20 ≤	V _{IN} ≤ -	-7)	(–27 ≤	V _{IN} ≤ -	14.5)	(–30 ≤	V _{IN} ≤ -	-17.5)	V
ΔV _O	Load	T _J = 25°C			50			100			125	mV
	Regulation	1mA ≤ I _O ≤ 100mA										
ΔV _O	Long Term Stability	I _O = 100mA		20			48			60		mV/ khrs
IQ	Quiescent Current	I _O = 100mA		2	6		2	6		2	6	mA
	Quiescen Current Change	1mA ≤ I _O ≤ 100mA			0.3			0.3			0.3	
		1mA ≤ I _O ≤ 40mA			0.1			0.1			0.1	mA
ΔI _Q		I _O = 100mA			0.25			0.25			0.25	mA
		$V_{MIN} \le V_{IN} \le V_{MAX}$	(–20 ≤	V _{IN} ≤ -	-7.5)	(–27 ≤	V _{IN} ≤ -	14.8)	(-30 ≤	V _{IN} ≤ -	-18)	V
V _n	Output Noise Voltage	$T_J = 25^{\circ}C, I_O = 100mA$ f = 10Hz - 10kHz		40			96			120		μV
$\frac{\Delta V_{IN}}{\Delta V_{O}}$	Ripple Rejection	$T_J = 25^{\circ}C, I_O = 100mA$ f = 120Hz	50			52			50			dB
	Input Voltage Required to	$T_J = 25^{\circ}C, I_O = 100mA$			-7.3			-14.6			-17.7	V
	Maintain Line Regulation	I _O = 40mA			-7.0			-14.5			-17.5	V

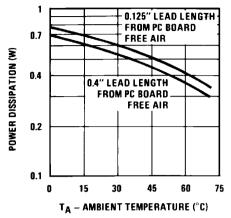
Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

Note 2: Thermal resistance of TO-3 (Z) package is 60° C/W θ_{JC} . 232° C/W θ_{JA} at still air, and 88° C/W at 400 ft/min of air. The θ_{JA} of the LM78LXX in the 6-Bump micro-SMD package is 114° C/W when mounted on a 4-Layer JEDEC test board (JESD 51-7). The θ_{JA} of the LM78LXX in the SOIC-8 (M) package is 180° C/W in still air. The maximum junction temperature shall not exceed 125° C on electrical parameters.

Note 3: To ensure constant junction temperature, low duty cycle pulse testing is used.

Typical Performance Characteristics

Maximum Average Power Dissipation (TO-92)



∆V_{OUT} = 100 mV 0.2 **OUTPUT CURRENT (A)** T_i = 25°C T_i = O°C 0.15 T_i = 125°C 0.1 0.05

10

15

INPUT-OUTPUT DIFFERENTIAL (V)

20

25

1₀ = 0 mA

Peak Output Current

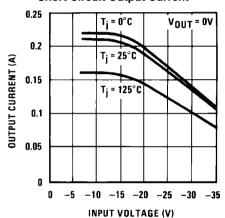
0.25

n

5

30

Short Circuit Output Current



774813

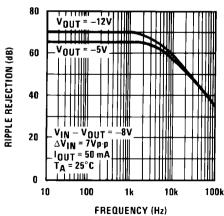
-12 V AND -15 V ∆V_{OUT}=100 mV INPUT-OUTPUT DIFFERENTIAL (V) = 100 mA -1 1₀ = 40 mĀ 10 = 0 mA 1₀ = 100 mA ΔV_{OUT} = 100 mV o = 40 mA -2

Dropout Voltage

25 75 100 125 T_i – JUNCTION TEMPERATURE (°C)

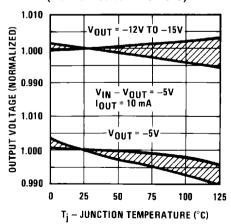
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Ripple Rejection

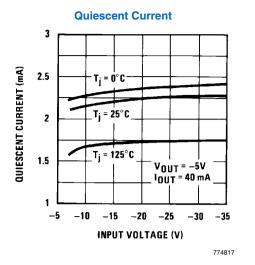


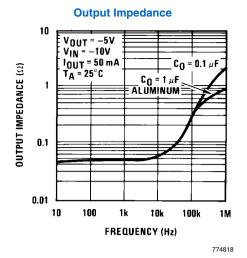
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Output Voltage vs. Temperature (Normalized to 1V @ 25°C)



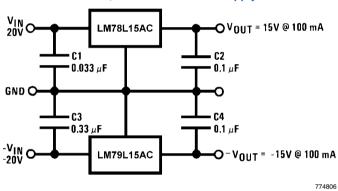
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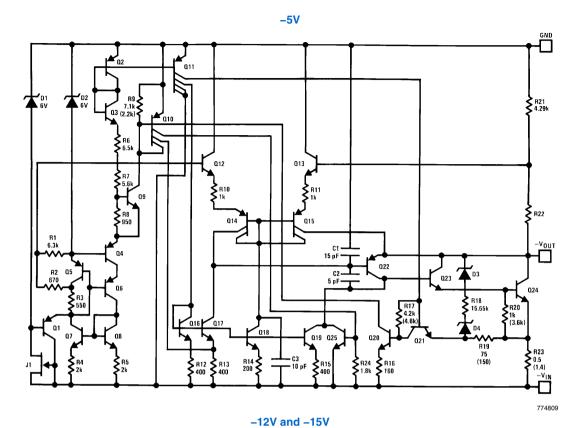


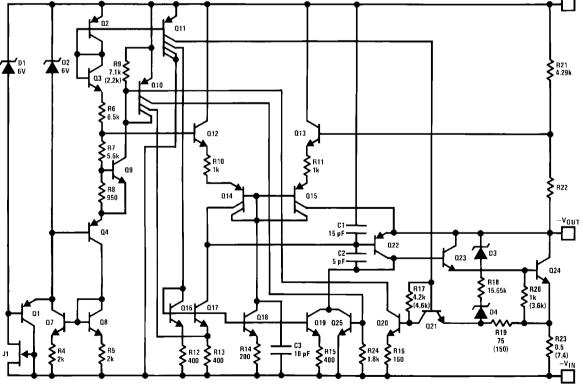
Typical Applications

±15V, 100mA Dual Power Supply

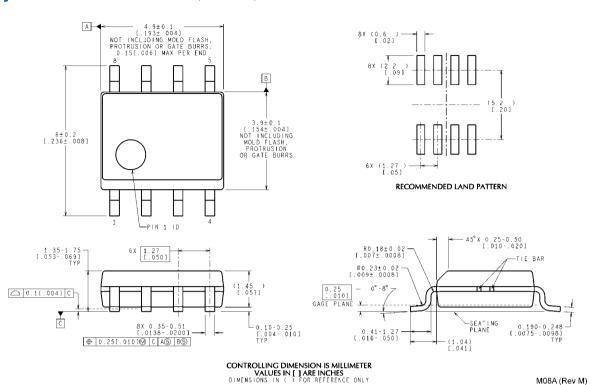


Schematic Diagrams





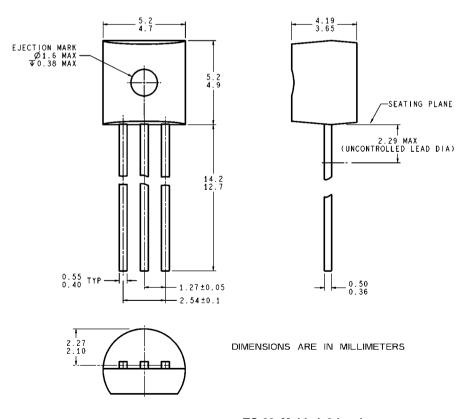
Physical Dimensions inches (millimeters) unless otherwise noted



8-Lead, SOIC NARROW

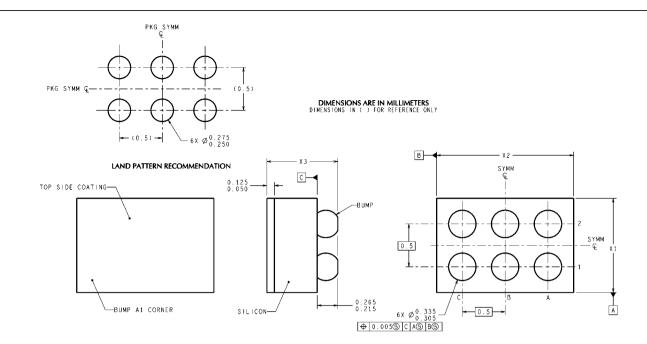
M08A (Rev M)

NS Package Number M08A



ZOSA (Rev G)

TO-92, Molded, 3-Lead **NS Package Number Z03A**



TLA06XXX (Rev C)

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. EPOXY COATING.
- 2. 63Sn/67Pb EUTECTIC BUMP.
- 3. RECOMMEND NON-SOLDER MASK DEFINED LANDING PAD.
- 4. PIN A1 ESTABLISHED BY LOWER LEFT CORNER WITH RESPECT TO TEXT ORIENTATION.
- 5. XXX IN DRAWING NUMBER REPRESENTS PACKAGE SIZE VARIATION WHERE X1 IS PACKAGE WIDTH, X2 IS PACKAGE LENGTH AND X3 IS PACKAGE HEIGHT.
- 6. REFERENCE JEEC REGISTRATION MO-211, VARIATION BC.

 $\begin{array}{ccc} & & & & & \\ & \text{NS Package Number TLA06AMA} \\ & \text{X}_1 = 1006 \mu \text{m} & \text{X}_2 = 1793 \mu \text{m} & \text{X}_3 = 600 \mu \text{m} \end{array}$

Notes

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